

LH531000B

CMOS 1M (128K × 8) MROM

FEATURES

- 131,072 words × 8 bit organization
- Access time: 150 ns (MAX.)
- Low power consumption:
Operating: 192.5 mW (MAX.)
Standby: 550 μ W (MAX.)
- Programmable $\overline{CE}/\overline{OE}/\overline{OE}$
- Static operation
- TTL compatible I/O
- Three-state outputs
- Single +5 V power supply
- Packages:
28-pin, 600-mil DIP
28-pin, 450-mil SOP
- Mask ROM specific pinout

DESCRIPTION

The LH531000B is a mask-programmable ROM organized as 131,072 × 8 bits. It is fabricated using silicon-gate CMOS process technology.

PIN CONNECTIONS

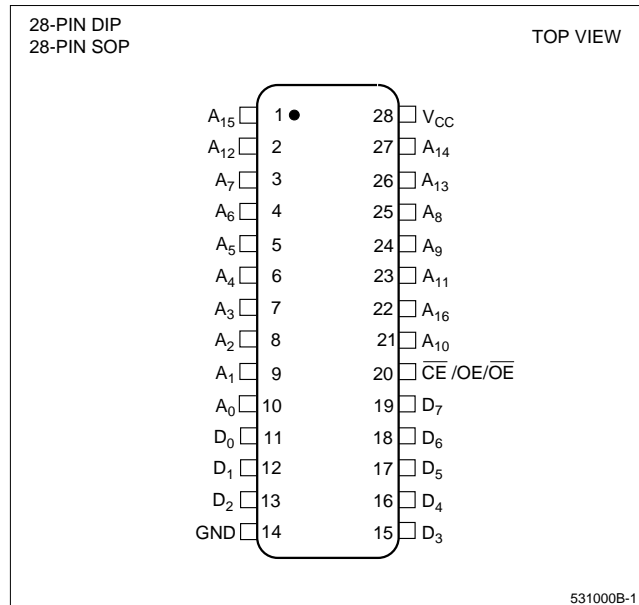


Figure 1. Pin Connections for DIP and SOP Packages

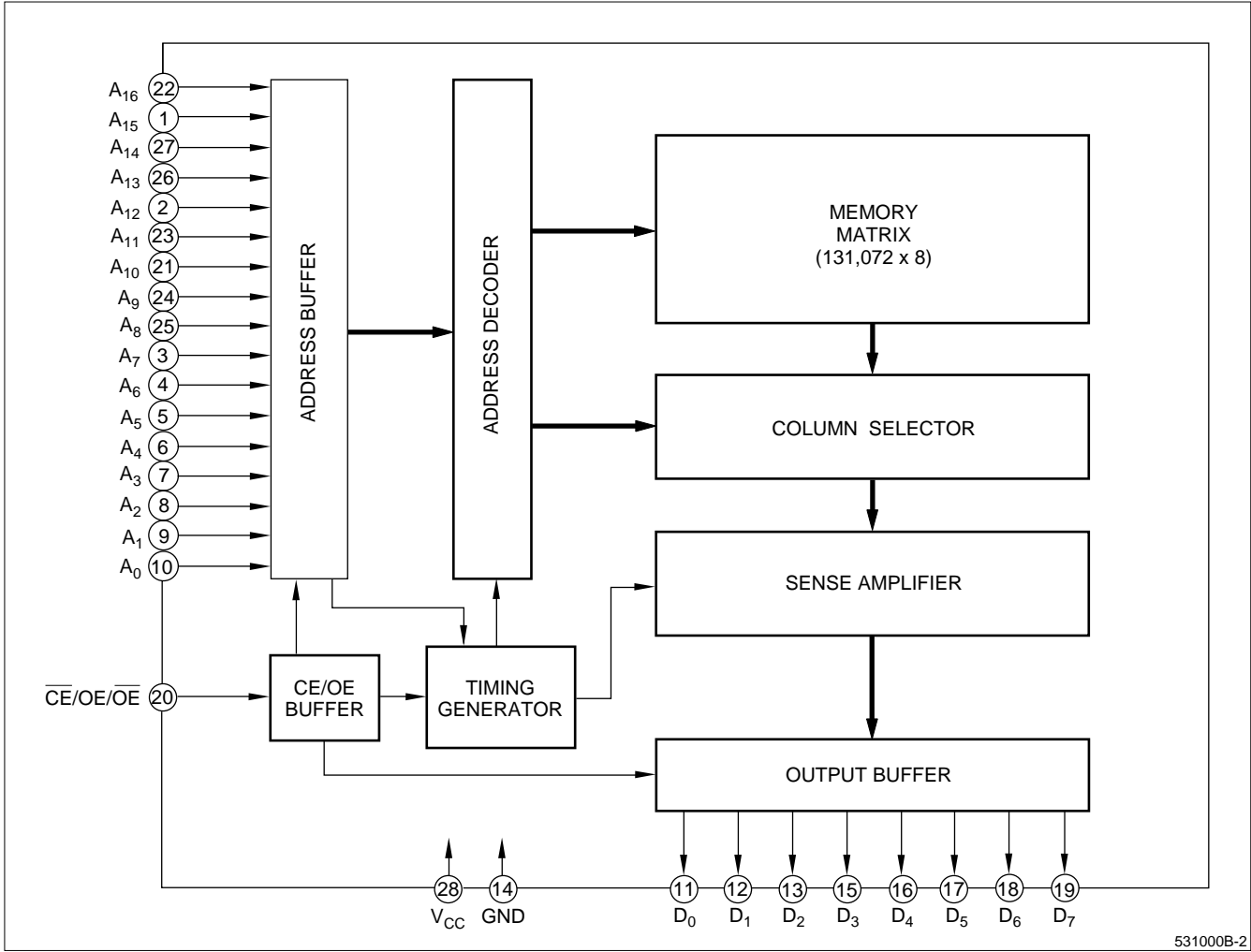


Figure 2. LH531000B Block Diagram

PIN DESCRIPTION

SIGNAL	PIN NAME	NOTE
A ₀ - A ₁₆	Address input	
D ₀ - D ₇	Data output	
CE/OE/OE	Chip Enable input or Output Enable input	1

SIGNAL	PIN NAME	NOTE
V _{CC}	Power supply (+5 V)	
GND	Ground	

NOTE:

1. Active level of CE/OE/OE is mask-programmable.

TRUTH TABLE

PIN 20	CE	OE/OE	MODE	D ₀ - D ₇	SUPPLY CURRENT
CE type	L	—	Selected	DOUT	Operating (I _{CC})
	H	—	Non selected	High-Z	Standby (I _{SB})
OE type	—	H/L	Selected	DOUT	Operating (I _{CC})
	—	L/H	Non selected	High-Z	

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Supply voltage	V_{CC}	-0.3 to +7.0	V
Input voltage	V_{IN}	-0.3 to $V_{CC} + 0.3$	V
Output voltage	V_{OUT}	-0.3 to $V_{CC} + 0.3$	V
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS ($T_A = 0$ to +70°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage	V_{CC}	4.5	5.0	5.5	V

DC CHARACTERISTICS ($V_{CC} = 5\text{ V} \pm 10\%$, $T_A = 0$ to +70°C)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Input 'Low' voltage	V_{IL}		-0.3		0.8	V	
Input 'High' voltage	V_{IH}		2.2		$V_{CC} + 0.3$	V	
Output 'Low' voltage	V_{OL}	$I_{OL} = 2.0\text{ mA}$			0.4	V	
Output 'High' voltage	V_{OH}	$I_{OH} = -400\text{ }\mu\text{A}$	2.4			V	
Input leakage current	$ I_{LI} $	$V_{IN} = 0\text{ V to } V_{CC}$			10	μA	
Output leakage current	$ I_{LO} $	$V_{OUT} = 0\text{ V to } V_{CC}$			10	μA	1
Operating current	I_{CC1}	$t_{RC} = 150\text{ ns}$			35	mA	2
	I_{CC2}	$t_{RC} = 1\text{ }\mu\text{s}$			25		
	I_{CC3}	$t_{RC} = 150\text{ ns}$			30	mA	3
	I_{CC4}	$t_{RC} = 1\text{ }\mu\text{s}$			20		
Standby current	I_{SB1}	$CE = V_{IH}$			2	mA	
	I_{SB2}	$CE = V_{CC} - 0.2\text{ V}$			100	μA	
Input capacitance	C_{IN}	$f = 1\text{ MHz}$			10	pF	
Output capacitance	C_{OUT}	$T_A = 25^\circ\text{C}$			10	pF	

NOTES:

1. $CE/OE = V_{IH}$, $OE = V_{IL}$
2. $V_{IN} = V_{IH}$ or V_{IL} , $CE = V_{IL}$, outputs open
3. $V_{IN} = (V_{CC} - 0.2\text{ V})$ or 0.2 V . $CE = 0.2\text{ V}$, outputs open

AC CHARACTERISTICS ($V_{CC} = 5\text{ V} \pm 10\%$, $T_A = 0$ to +70°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Read cycle time	t_{RC}	150			ns	
Address access time	t_{AA}			150	ns	
Chip enable access time	t_{ACE}			150	ns	
Output enable time	t_{OE}			70	ns	
Output hold time	t_{OH}	5			ns	
CE to output in High-Z	t_{CHZ}			70	ns	1
OE to output in High-Z	t_{OHZ}			70	ns	

NOTE:

1. This is the time required for the output to become high-impedance.

AC TEST CONDITIONS

PARAMETER	RATING
Input voltage amplitude	0.6 V to 2.4 V
Input rise/fall time	10 ns
Input reference level	1.5 V
Output reference level	0.8 V and 2.2 V
Output load condition	1TTL +100 pF

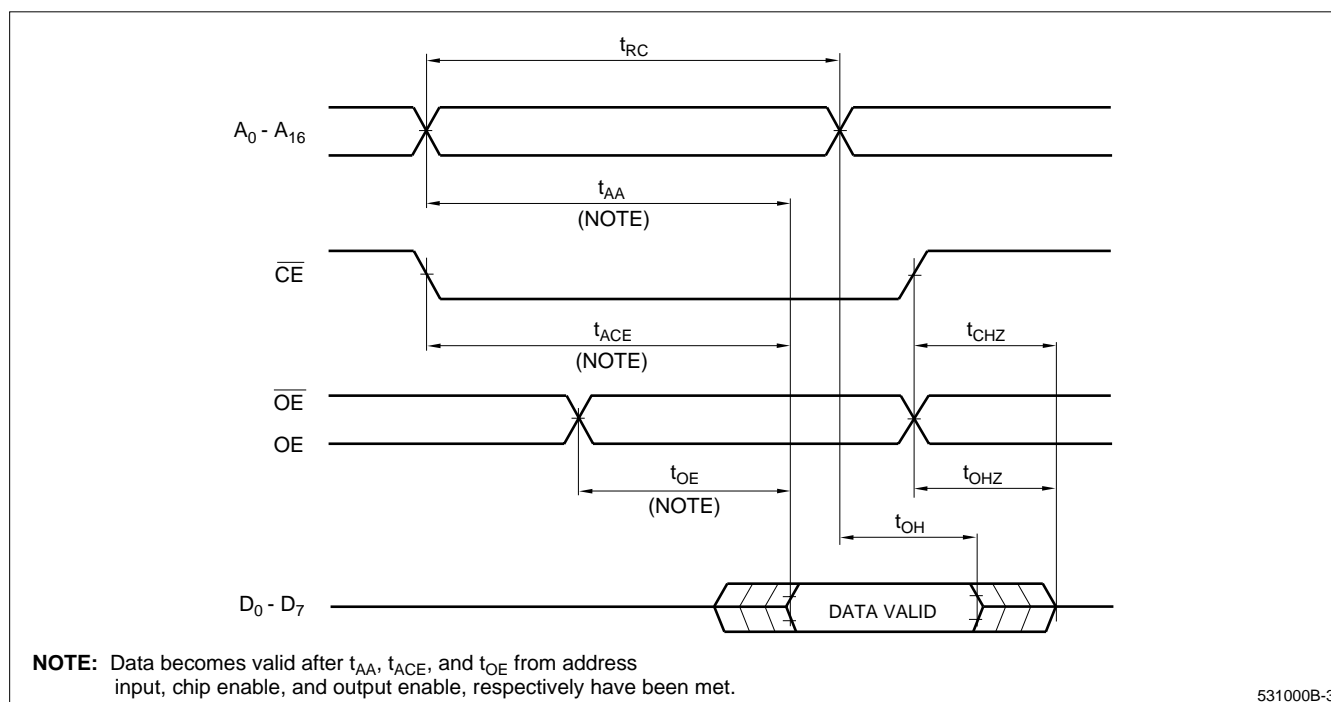
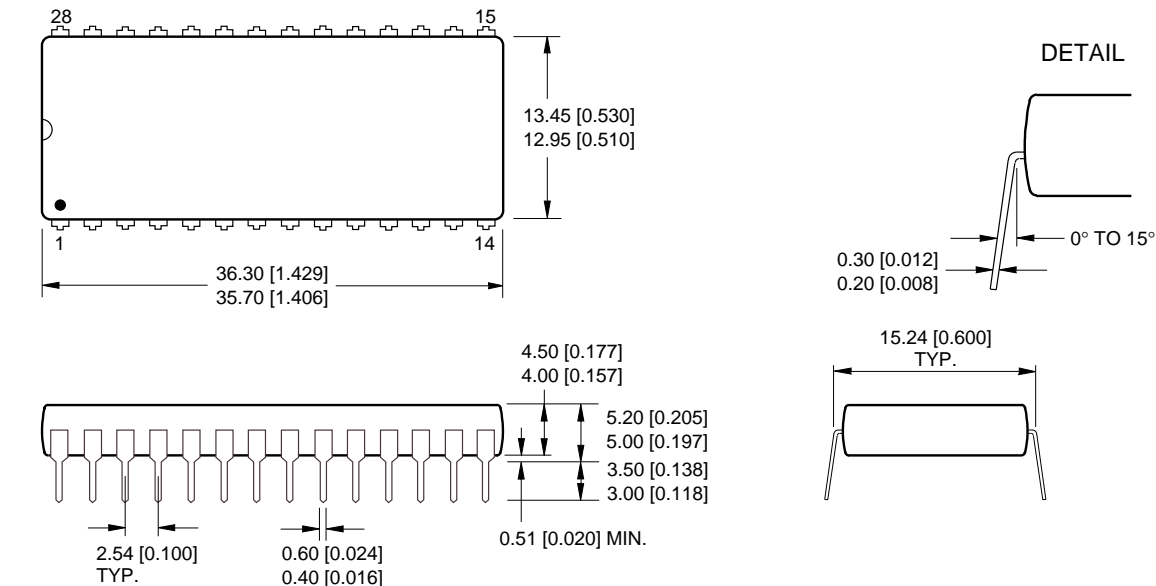


Figure 3. Timing Diagram

PACKAGE DIAGRAMS

28DIP (DIP028-P-0600)

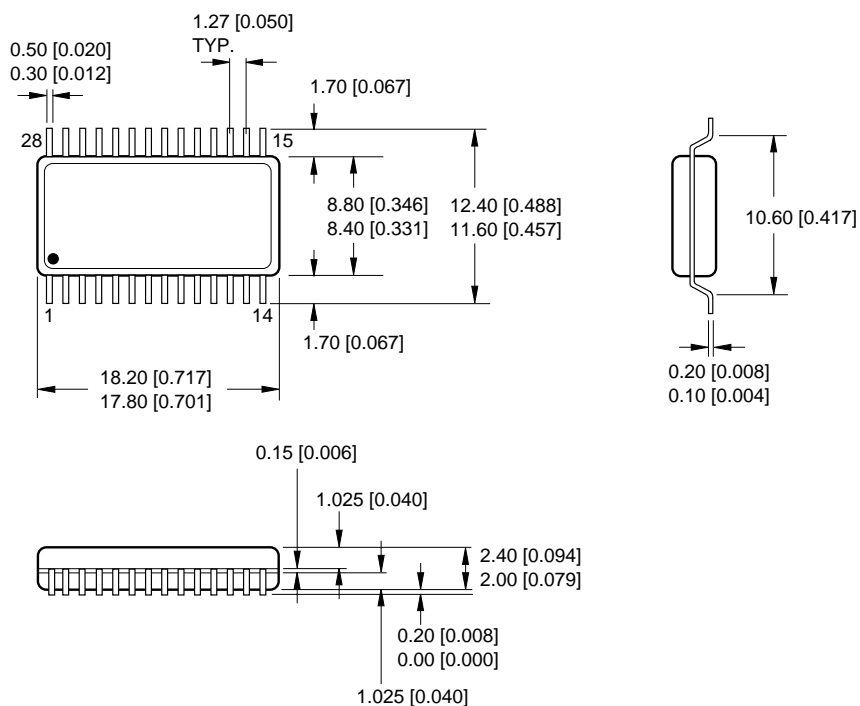


DIMENSIONS IN MM [INCHES] MAXIMUM LIMIT
MINIMUM LIMIT

28DIP-2

28-pin, 600-mil DIP

28SOP (SOP028-P-0450)



DIMENSIONS IN MM [INCHES] MAXIMUM LIMIT
MINIMUM LIMIT

28SOP

28-pin, 450-mil SOP

ORDERING INFORMATION